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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
10/659,181	09/10/2003	Greg E. Howard	TI-36332 (032350.B531)	7485	
23494	7590 07/01/2005		EXAM	EXAMINER	
	TRUMENTS INCOR	CLARK, SHEILA V			
P O BOX 655474, M/S 3999 DALLAS, TX 75265			ART UNIT	PAPER NUMBER	
			2815		

DATE MAILED: 07/01/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)				
Office Action Summan	10/659,181	HOWARD ET AL				
Office Action Summary	Examiner	Art Unit				
	S. V. Clark	2815				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPLY THE MAILING DATE OF THIS COMMUNICATION. - Extensions of time may be available under the provisions of 37 CFR 1.13 after SIX (6) MONTHS from the mailing date of this communication. - If the period for reply specified above is less than thirty (30) days, a reply - If NO period for reply is specified above, the maximum statutory period w - Failure to reply within the set or extended period for reply will, by statute, Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	6(a). In no event, however, may a reply be timwithin the statutory minimum of thirty (30) days ill apply and will expire SIX (6) MONTHS from cause the application to become ABANDONE	ely filed s will be considered timely. the mailing date of this communication. O (35 U.S.C. § 133).				
Status						
1) Responsive to communication(s) filed on 6-10-	<u>2005</u> .					
2a) ☐ This action is FINAL . 2b) ☒ This	2a) This action is FINAL . 2b) ⊠ This action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
Disposition of Claims	•					
 4) Claim(s) 1-4,7,8 and 15-21 is/are pending in the 4a) Of the above claim(s) is/are withdraw 5) Claim(s) is/are allowed. 6) Claim(s) 1-4,7,8 and 15-21 is/are rejected. 7) Claim(s) 6 is/are objected to. 8) Claim(s) are subject to restriction and/or 	n from consideration.					
Application Papers						
9) The specification is objected to by the Examiner 10) The drawing(s) filed on is/are: a) access applicant may not request that any objection to the consequence of the consequen	epted or b) objected to by the Edrawing(s) be held in abeyance. See on is required if the drawing(s) is obj	ected to. See 37 CFR 1.121(d).				
Priority under 35 U.S.C. § 119						
 12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f). a) All b) Some * c) None of: 1. Certified copies of the priority documents have been received. 2. Certified copies of the priority documents have been received in Application No. 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
Attachment(s) 1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08) Paper No(s)/Mail Date	4) Interview Summary Paper No(s)/Mail Da 5) Notice of Informal P 6) Other:					

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The finality of the last office action has been rescinded so that the forenoted action may be submitted.

The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.

Claims 1-4, 7, 8, 15-21 are rejected under 35 U.S.C. 102(b) as anticipated by or, in the alternative, under 35 U.S.C. 103(a) as obvious over Ohno et al.

Ohno et al shows in for example figures 9-11 providing a substrate 40 having a plurality of through holes 24 formed therein with each hole associated with a plurality of contact pads 2 in the form of leads 2 formed on a first bottom surface. A plurality of balls 6 are taught disposed within ones of the plurality of holes and projecting outward from said first surface (Figure 10B). A force 53 (a press) is shown in figure 10 applied to each of the balls outwardly from the first surface to couple the balls to the substrate 40 (figure 10D).

Col. 11, line 31 describes substrate 40 as being formed of a pile of layers would have been to one having ordinary skill in this art to be obviously describing a laminate, used common in semiconductor substrate technology.

Figure 10C shows said formed applied to each of said balls (simultaneously) and a press tool is taught wherein press may be used interchangeable as a punch and as pressing tools may punch.

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Further Ohno et al teaches the process of thermal compression bonding which would includes a heating step that heats the pressing tool (see col. 4, lines 17-19).

Further the as the claims fail to recite a specific process for heating said tool said tool would inherently by heated by the ambient temperature.

It is taught that that said balls are pushed through a substrate such that a portion extends outside said through hole. As the balls are taught to have a diameter of 90 the holes 80 and the substrate 40 micrometers it would seem that there would be some overlap of the protruding portion of the balls relative to the substrate.

Col. 12, line 34 teaches that said ball may project outwardly by a distance of 45 microns in the range recited in claim 4.

Claims 1-4, 7, 8, 15-21 are rejected.

Heating of the punch tool in the claims has been reconsidered. It is deemed that there several factors that would affect the heating of said tool including thermocompression bonding and even inherent provided environmental factors such as ambient temperature. Since the claims provide no particular process that would effect the heating of said tool apart from these factors the rejection above is deemed to be proper.

Any inquiry concerning this communication should be directed to S. V. Clark at telephone number (571) 272-1725.

Primary Examiner
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